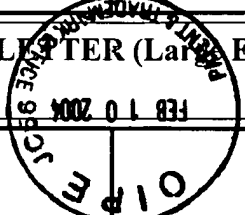
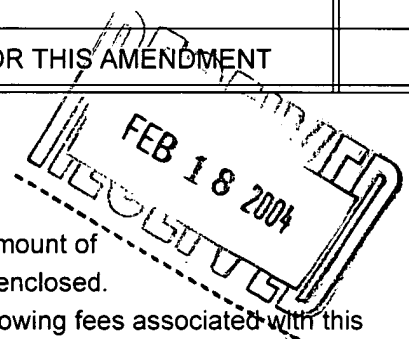
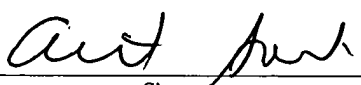
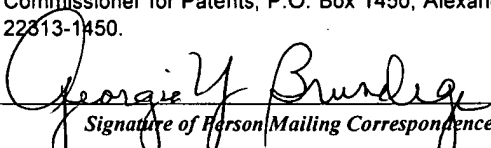
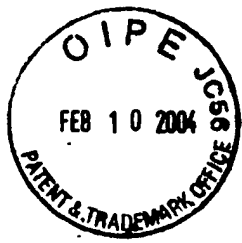


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1733

AMENDMENT TRANSMITTAL LETTER (Large Entity)				Docket No. JP920000346US1	
Applicant(s): S. Kobayashi					
Serial No. 10/068,400	Filing Date 02/26/2002		Examiner J. T. Haran	Group Art Unit 1733	
Invention: BONDING METHOD AND APPRATUS					
<u>TO THE COMMISSIONER FOR PATENTS:</u> Transmitted herewith is an amendment in the above-identified application. The fee has been calculated and is transmitted as shown below.					
CLAIMS AS AMENDED					
	CLAIMS REMAINING AFTER AMENDMENT	HIGHEST # PREV. PAID FOR	NUMBER EXTRA CLAIMS PRESENT	RATE	ADDITIONAL FEE
TOTAL CLAIMS	-	20 =	0 x	\$18.00	\$0.00
INDEP. CLAIMS	-	3 =	0 x	\$86.00	\$0.00
Multiple Dependent Claims (check if applicable) <input type="checkbox"/>					\$0.00
TOTAL ADDITIONAL FEE FOR THIS AMENDMENT					\$0.00
<div style="float: right; text-align: right;">  </div> <input checked="" type="checkbox"/> No additional fee is required for amendment. <input type="checkbox"/> Please charge Deposit Account No. _____ in the amount of _____ <input type="checkbox"/> A check in the amount of _____ to cover the filing fee is enclosed. <input checked="" type="checkbox"/> The Director is hereby authorized to charge payment of the following fees associated with this communication or credit any overpayment to Deposit Account No. 09-0457 <input checked="" type="checkbox"/> Any additional filing fees required under 37 C.F.R. 1.16. <input type="checkbox"/> Any patent application processing fees under 37 CFR 1.17.					
 _____ Signature			Dated: 2/6/2014		
Arthur J. Samodovitz Reg. No: 31,297 IBM Corporation Dept. IQ0A/bldg. 40-3 1701 North Street Endicott, NY 13760					
I certify that this document and fee is being deposited on 2-2-04 with the U.S. Postal Service as first class mail under 37 C.F.R. 1.8 and is addressed to the Commissioner for Patents, P.O. Box 1450, Alexandria, VA 22313-1450.  _____ Signature of Person Mailing Correspondence <div style="text-align: center;">Georgia Y. Brundege</div> <div style="text-align: center;">Typed or Printed Name of Person Mailing Correspondence</div>					
cc: RECORDS					



IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

In re Patent Application:
S. Kobayashi
Serial No.: 10/068,400
Filed: 02/06/2002
Title: BONDING METHOD AND
APPARATUS

: Group Art Unit: 1733
: Examiner: J. T. Haran
: IBM Corporation
: Intellectual Property Law
: Department IQ0A/040-3
: 1701 North Street
: Endicott, NY 13760

Assistant Commissioner For Patents

Washington, DC 20231

Sir:

I hereby certify that this correspondence
is being deposited with the United States
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Alexandria, VA 22313-1450, on

2-6-04
Georgia Y. Brundage 2-6-04
Georgia Y. Brundage Date

RESPONSE

In response to the Office Action dated 12/19/2003, please amend the above-identified application as follows:

IN THE CLAIMS:

- 1.(Canceled) A bonding method of bonding first and second members to one another, said bonding method comprising the steps of:
- positioning thermosetting resin between said first member and said second member;
- bonding said first member to said second member by heating and curing said thermosetting resin by irradiation of electromagnetic waves onto said thermosetting resin,